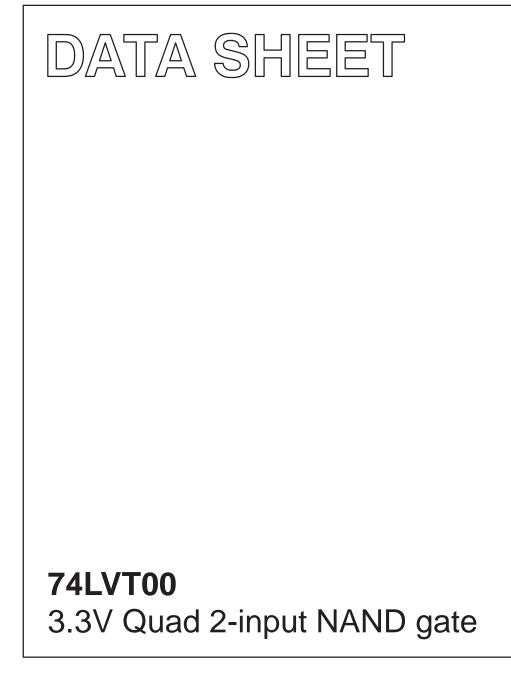
INTEGRATED CIRCUITS



Product specification IC24 Data Handbook 1996 Aug 15



Philips Semiconductors

74LVT00

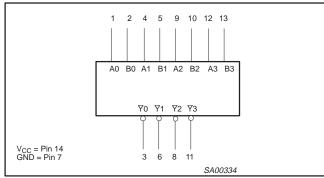
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS T _{amb} = 25°C; GND = 0V | TYPICAL | UNIT |
|--------------------------------------|--|--|------------|------|
| t _{PLH} t _{PHL} | Propagation delay An or Bn to Yn | C _L = 50pF; V _{CC} = 3.3V | 2.7 2.7 | ns |
| C _{IN} | Input capacitance | $V_{I} = 0V \text{ or } 3.0V$ | 3 | pF |
| I _{CCL} | Total supply current | Outputs Low; $V_{CC} = 3.6V$ | 1 | mA |

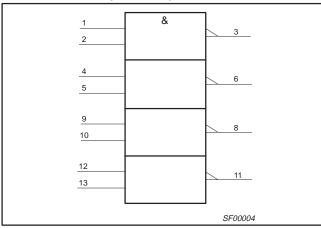
ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
|----------------------|-------------------|-----------------------|---------------|------------|
| 14-Pin Plastic SO | –40°C to +85°C | 74LVT00 D | 74LVT00 D | SOT108-1 |
| 14-Pin Plastic SSOP | –40°C to +85°C | 74LVT00 DB | 74LVT00 DB | SOT337-1 |
| 14-Pin Plastic TSSOP | -40°C to +85°C | 74LVT00 PW | 74LVT00PW DH | SOT402-1 |

LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



PIN CONFIGURATION

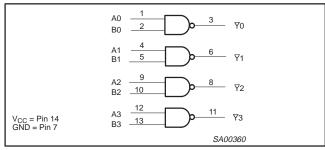
| A0 1 | | V _{CC} |
|---|---------|-----------------|
| B0 2 | Ľ | B3 |
| Y0 3 | 12 | A3 |
| A1 4 | 11 | <u>¥</u> 3 |
| B1 5 | 10 | B2 |
| <u></u> | 9 | A2 |
| GND 7 | 8 | <u>¥</u> 2 |
| • | SA00333 | |

PIN DESCRIPTION

| PIN NUMBER | SYMBOL | NAME AND FUNCTION |
|------------------------------|-----------------|-------------------------|
| 1, 2, 4, 5, 9, 10, 12, 13 | An-Bn | Data inputs |
| 3, 6, 8, 11 | ₹ | Data outputs |
| 7 | GND | Ground (0V) |
| 14 | V _{CC} | Positive supply voltage |

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LOGIC DIAGRAM



FUNCTION TABLE

| INF | UTS | OUTPUT |
|-----|-----|--------|
| Dna | Dnb | Qn |
| L | L | Н |
| L | Н | Н |
| н | L | Н |
| н | Н | L |

NOTES:

H = High voltage level L = Low voltage level

ABSOLUTE MAXIMUM RATINGS^{1, 2}

| SYMBOL | PARAMETER | PARAMETER CONDITIONS | | UNIT | |
|------------------|--------------------------------|---------------------------------------|--------------|------|--|
| V _{CC} | DC supply voltage | | -0.5 to +4.6 | V | |
| l _{IK} | DC input diode current | V ₁ < 0 | -50 | mA | |
| VI | DC input voltage ³ | | -0.5 to +7.0 | V | |
| Ι _{ΟΚ} | DC output diode current | Coutput diode current $V_{\rm O} < 0$ | | mA | |
| V _{OUT} | DC output voltage ³ | Output in Off or High state | -0.5 to +7.0 | V | |
| 1 | | Output in High state | | | |
| lout | DC output current | Output in Low state | 64 | — mA | |
| T _{stg} | Storage temperature range | | -65 to 150 | °C | |

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction 2. temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | LIM | UNIT | |
|------------------|---|-----|------|------|
| STMBOL | PARAMETER | MIN | MAX | UNIT |
| V _{CC} | DC supply voltage | 2.7 | 3.6 | V |
| VI | Input voltage | | 5.5 | V |
| V _{IH} | High-level input voltage | 2.0 | | V |
| V _{IL} | Low-level Input voltage | | 0.8 | V |
| I _{ОН} | High-level output current | | -20 | mA |
| I _{OL} | Low-level output current | | 32 | mA |
| Δt/Δv | Input transition rise or fall rate; Outputs enabled | | 10 | ns/V |
| T _{amb} | Operating free-air temperature range | -40 | +85 | °C |

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions Voltages are referenced to \vec{GND} (ground = 0V)

| | | | LIMITS Temp = -40°C to +85°C | | | UNIT | |
|------------------|--|--|---------------------------------|------------------|------|------|--|
| SYMBOL | PARAMETER | TEST CONDITIONS | | | | | |
| | | | MIN | TYP ¹ | МАХ | 1 | |
| V _{IK} | Input clamp voltage | $V_{CC} = 2.7V; I_{IK} = -18mA$ | | | -1.2 | V | |
| | | $V_{CC} = 2.7$ to 3.6V; $I_{OH} = -100\mu A$ | V _{CC} -0.2 | | | | |
| V _{OH} | High-level output voltage | $V_{CC} = 2.7V; I_{OH} = -6mA$ | 2.4 | | | V | |
| | | $V_{CC} = 3.0V; I_{OH} = -20mA$ | 2.0 | | | | |
| | | V _{CC} = 2.7V; I _{OL} = 100μA | | | 0.2 | v | |
| V _{OL} | Low-level output voltage | V _{CC} = 2.7V; I _{OL} = 24mA | | | 0.5 | | |
| | | $V_{CC} = 3.0V; I_{OL} = 32mA$ | | | 0.5 | | |
| | | V _{CC} = 0 or 3.6V; V _I = 5.5V | | | 10 | | |
| I _I | Input leakage current | V_{CC} = 3.6V; V_I = V_{CC} or GND | | | ±1 | μΑ | |
| I _{OFF} | Output off current | V_{CC} = 0V; V_{I} or V_{O} = 0 to 4.5V | | | ±100 | μΑ | |
| I _{ССН} | | V_{CC} = 3.6V; Outputs High, V_{I} = GND or V_{CC} , I_{O} = 0 | | | 0.02 | | |
| ICCL | Quiescent supply current | V_{CC} = 3.6V; Outputs Low, V_{I} = GND or $V_{CC,}$ I_{O} = 0 | | 1 | 2 | mA | |
| ΔI _{CC} | Additional supply current per input pin ² | V_{CC} = 3V to 3.6V; One input at V_{CC}=0.6V, Other inputs at V_{CC} or GND | | | 0.2 | μA | |
| CI | Input capacitance | $V_I = 3V \text{ or } 0$ | | 3 | | pF | |

NOTES:

1. All typical values are at $V_{CC} = 3.3V$ and $T_{amb} = 25^{\circ}C$. 2. This is the increase in supply current for each input at the specificed voltage level other than V_{CC} or GND.

AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5ns$; $C_L = 50pF$, $R_L = 500\Omega$; $T_{amb} = -40^{\circ}C$ to +85°C.

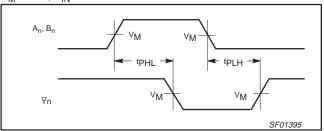
| SYMBOL | PARAMETER | WAVEFORM | $V_{CC} = 3.3V \pm 0.3V$ | | | V _{CC} = 2.7V | UNIT |
|--------------------------------------|-------------------------------------|----------|--------------------------|------------------|------------|------------------------|------|
| | | | MIN | TYP ¹ | MAX | MAX | |
| t _{PLH} t _{PHL} | Propagation delay An or Bn to Yn | 1 | 1.0 1.0 | 2.7 2.7 | 4.1 3.9 | 5.0 3.8 | ns |

NOTE:

1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25^{\circ}C.

AC WAVEFORMS

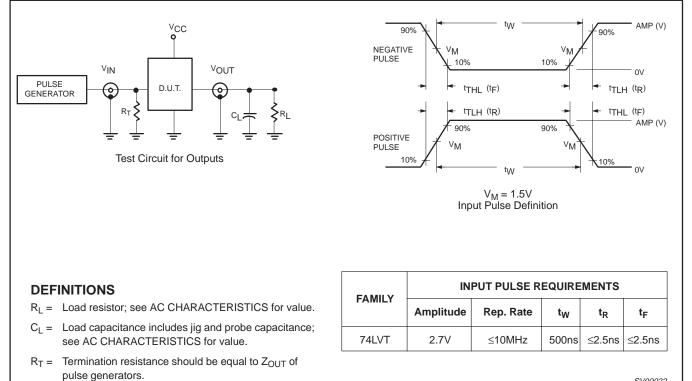
 $V_{\rm M} = 1.5 V, V_{\rm IN} = {\rm GND} \text{ to } 2.7 V$



Waveform 1. Propagation delay for inverting outputs

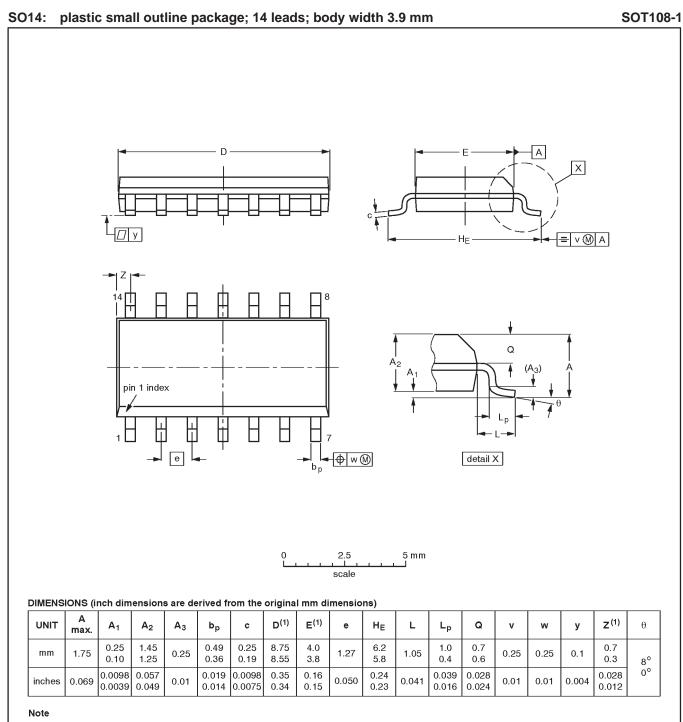
74LVT00

TEST CIRCUIT AND WAVEFORMS



SV00022

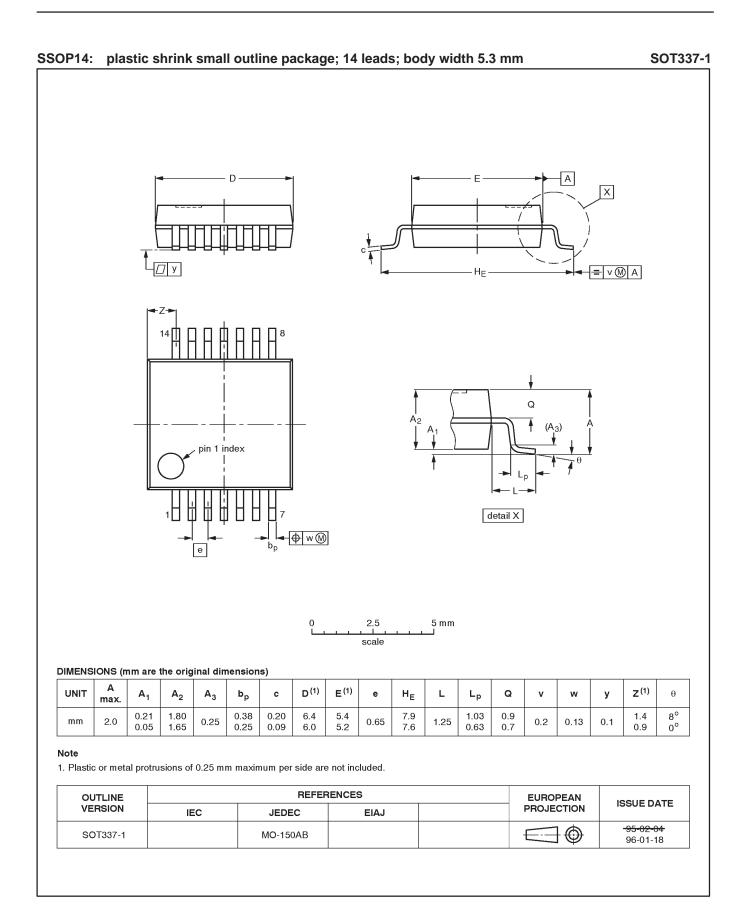
74LVT00



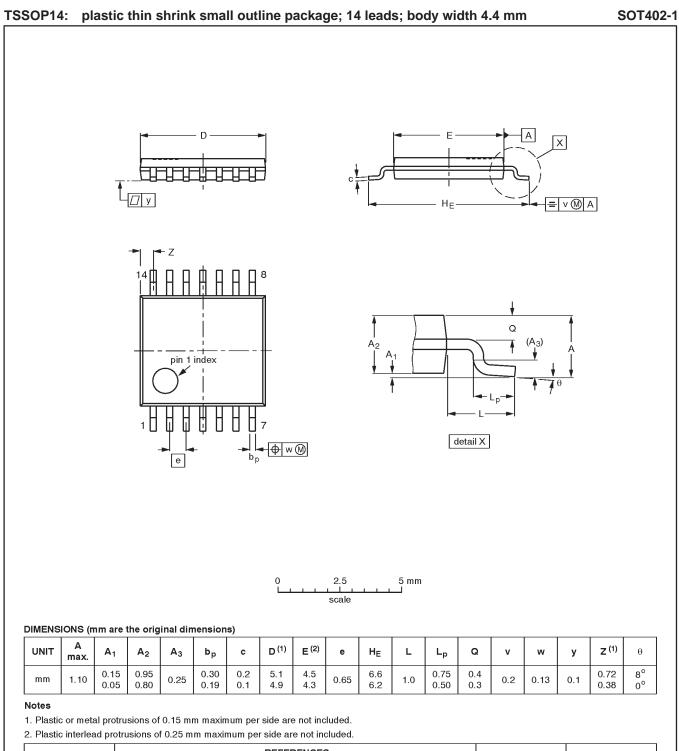
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE | | REFERENCES | | | | | |
|----------|---------|------------|------|--|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE | |
| SOT108-1 | 076E06S | MS-012AB | | | | 91-08-13 95-01-23 | |

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| OUTLINE | | REFERENCES | | | EUROPEAN ISSUE DATE | | |
|----------|-----|------------|------|--|---------------------|----------------------------------|--|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | 1550E DATE | |
| SOT402-1 | | MO-153 | | | | -94-07-12 95-04-04 | |

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NOTES

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| DEFINITIONS | | | | |
|---------------------------|------------------------|--|--|--|
| Data Sheet Identification | Product Status | Definition | | |
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| | | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. | | |
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